



Mikropočítačové Systémy – MIPS 2. prednáška

Embedded Computing / vnorené systémy

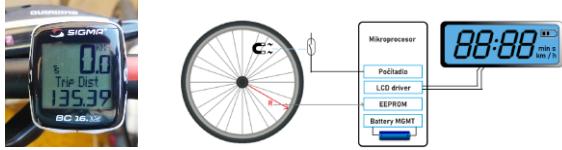


počítač = súčiastka

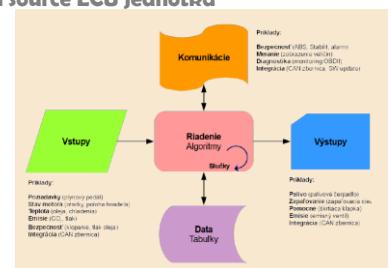


Vnorené systémy Embedded systems

embedded system
Systém spracovania informácií, ktorý je navrhnutý na špecifický účel v rámci väčšieho systému, často s požiadavkou na prácu v *rednom* čase.



Vnorené systémy microRusEfi = open source ECU jednotka



Internet vecí Internet of Things



The first generation (1982)

Mike Kazar
David Nichols
Software)
John Zsarnay
Ivor Durham
(Server Software)
(Documentation and User
(Hardware)
(Finger interface)

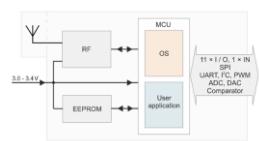
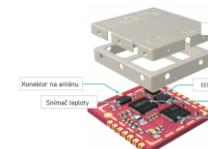
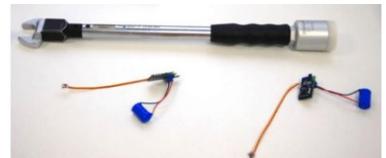
MTBC = 12 min
(Mean Time Between Cola)



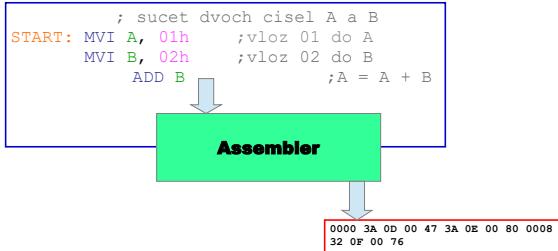
<http://www.cs.cmu.edu/~coker/>



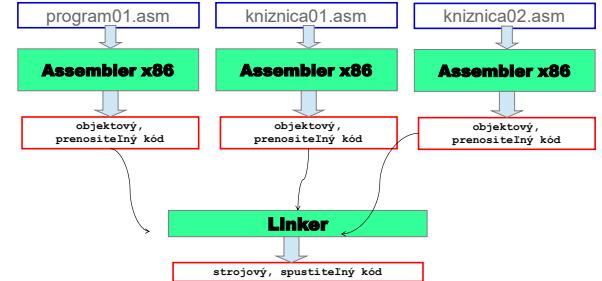
Internet vecí Internet of Things



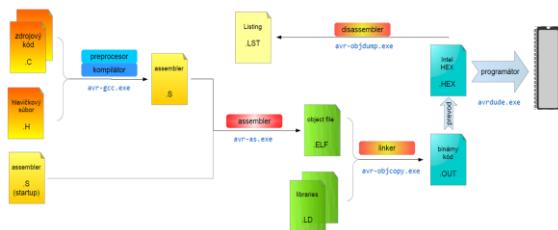
Strojový kód vs. jazyk symbolických adries



Kompilátor – prekladač + linker



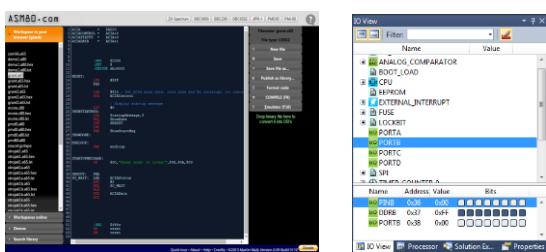
Vývojové prostriedky pre vnorené systémy



Vývojové prostriedky pre vnorené systémy



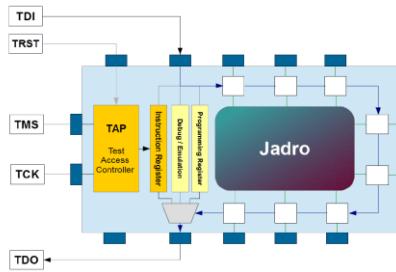
Simulátor procesora



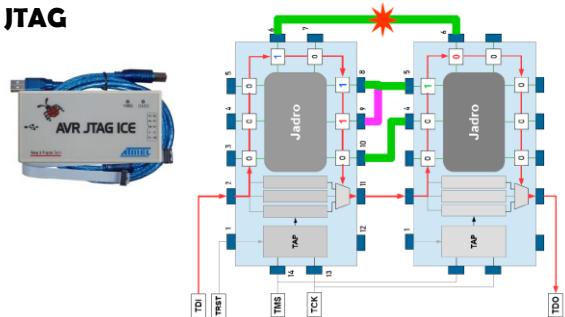
Emulátor procesora



Rozhranie JTAG



JTAG

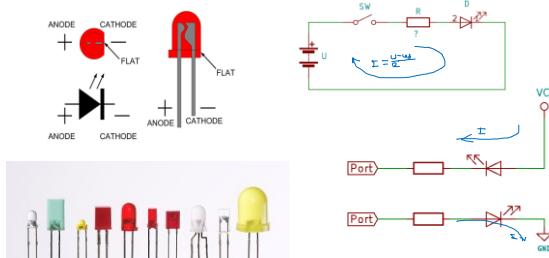


Prenesenie programu do pamäti AVR

- paralelný programátor
- programovanie cez SPI rozhranie (MISO/MOSI)
- programovanie cez JTAG alebo debugWire
- programovanie bootloaderom

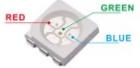


Jednabitový výstup - LED Light Emitting Diode



Price excl. VAT	20 pcs	40 pcs	200 pc*	1000 pc*	6000 pc*
0,0895 €	0,0649 €	0,0544 €	0,0504 €	0,0495 €	

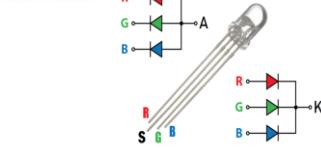
Jednobitový výstup



5050 RGB Chip



3 chips in 1 LED



Elektrické parametre (naučme sa čítať datasheet)

28.1 Absolute Maximum Ratings

Stressing parts beyond the limits of these absolute maximum ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

Parameter ¹	Min.	Typ.	Max.	Unit
Operating temperature	-55		+125	°C
Storage temperature	-65		+150	°C
Voltage on any pin except RESET with respect to ground	-0.5		$V_{CC} + 0.5$	V
Voltage on RESET with respect to ground	-0.5		$+13.0$	V
Maximum operating voltage		6.0		V
DC current per I/O pin		ΣI_{IO}		mA
DC current per V _{DD} and V _{SS} pins		ΣI_{VDD}		mA
Injection current at $V_{CC} = 5V$	$\pm 5.0^{(1)}$			mA
Injection current at $V_{CC} = 3V$	± 1.0			mA

Note: 1. Maximum current per port is $\pm 200\text{mA}$.



Elektrické parametre 2

28.2 DC Characteristics (Continued)

$T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$, $V_{CC} = 2.7$ to 5.5 V (unless otherwise noted)

Parameter	Condition	Symbol	Min.	Typ.	Max.	Unit
Input low voltage, RESET pin	$V_{CC} = 2.7$ to 5.5 V	V_{IL}	-0.5		$0.1V_{CC}^{(1)}$	V
Input high voltage, RESET pin	$V_{CC} = 2.7$ to 5.5 V	V_{IH}	$0.9V_{CC}^{(2)}$		$V_{CC} + 0.5$	V
Output low voltage ⁽³⁾	$I_{OL} = 20\text{mA}$, $V_{CC} = 5\text{V}$ $I_{OL} = 5\text{mA}$, $V_{CC} = 3\text{V}$	V_{OL}	0.8		0.5	V
Output high voltage ⁽⁴⁾	$I_{OH} = -20\text{mA}$, $V_{CC} = 5\text{V}$ $I_{OH} = -5\text{mA}$, $V_{CC} = 3\text{V}$	V_{OH}	2.3			V
Input leakage, Current I/O pin	$V_{CC} = 5.5\text{V}$, pin low (absolute value)	I_L		1	μA	
Input leakage, Current I/O pin	$V_{CC} = 5.5\text{V}$, pin high (absolute value)	I_H		1	μA	
Reset pull-up resistor	R_{RESET}		30	60	100	kΩ
I/O pin pull-up resistor	R_{PU}		20	50	100	kΩ
Analog comparator	$0.4\text{V} < V_{IN} < V_{CC} - 0.5$ (absolute value)	V_{ACOO}		10	40	mV
Input offset voltage	$V_{OC} = 5\text{V}$	I_{AOFF}	-50			nA
Analog comparator	$V_{OC} = 5\text{V}$	I_{AOFF}	-50			nA
Input leakage current	$V_{CC} = V_{OC}/2$					

Notes:

1. "Max" means the highest value where the pin is guaranteed to be read as low

2. "Min" means the lowest value where the pin is guaranteed to be read as high

3. Although each I/O port can sink more than the test conditions (20mA at $V_{CC} = 5\text{V}$, 10mA at $V_{CC} = 3\text{V}$) under steady state conditions (non-transient), the following must be observed:

(Atmega328P-16AU)

1) The sum of all I_{OL} for ports C0 - C5, should not exceed 100mA.

2) The sum of all I_{OL} for ports B0 - B5, D5 - D7, XTAL1, XTAL2 should not exceed 100mA.

3) The sum of all I_{OL} for ports D0 - D4, should not exceed 100mA.

Elektrické parametre 3

28.2 DC Characteristics

$T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$, $V_{CC} = 2.7$ to 5.5 V (unless otherwise noted)

Parameter	Condition	Symbol	Min.	Typ.	Max.	Unit
Input low voltage, except XTAL1 and RESET pin	$V_{CC} = 2.7$ to 5.5 V	V_{IL}	-0.5		$0.3V_{CC}^{(1)}$	V
Input high voltage, except XTAL1 and RESET pin	$V_{CC} = 2.7$ to 5.5 V	V_{IH}	$0.6V_{CC}^{(2)}$		$V_{CC} + 0.5$	V
Input low voltage, XTAL1 pin	$V_{CC} = 2.7$ to 5.5 V	V_{IL1}	-0.5		$0.1V_{CC}^{(1)}$	V
Input high voltage, XTAL1 pin	$V_{CC} = 2.7$ to 5.5 V	V_{IH1}	$0.7V_{CC}^{(2)}$		$V_{CC} + 0.5$	V

Notes:

1. "Max" means the highest value where the pin is guaranteed to be read as low
2. "Min" means the lowest value where the pin is guaranteed to be read as high
3. Although each I/O port can sink more than the test conditions (20mA at $V_{CC} = 5\text{V}$, 10mA at $V_{CC} = 3\text{V}$) under steady state conditions (non-transient), the following must be observed:

(Atmega328P-16AU)

- The sum of all I_{OL} for ports C0 - C5, should not exceed 100mA .
The sum of all I_{OL} for ports B0 - B5, D5 - D7, XTAL1, XTAL2 should not exceed 100mA .
- The sum of all I_{OL} for ports D0 - D4, should not exceed 100mA .
If I_{OL} exceeds the test condition, V_{OL} may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test condition.
- Although each I/O port can source more than the test conditions (20mA at $V_{CC} = 5\text{V}$, 10mA at $V_{CC} = 3\text{V}$) under steady state conditions (non-transient), the following must be observed:
Atmega328P-16AU
 - The sum of all I_{OL} for ports C0 - C5, should not exceed 100mA .
The sum of all I_{OL} for ports B0 - B5, D5 - D7, XTAL1, XTAL2 should not exceed 150mA .
 - If I_{OL} exceeds the test condition, V_{OL} may exceed the related specification. Pins are not guaranteed to source current greater than the listed test condition.

Inžiniering...

Výpočet

Uložen je navrhnutý rezistor R, tak, aby LED diódu tieklo dostatočne, ale ne zbytočne príliš veľký prúd.

Zdroj je $U_2 = 3.0 - 2.0 = 1.0$ [V].

Zdroj (datasheet) odčítame hodnotu $U_1 = 2.0$ [V].

Teraz vieme vypočítať hodnotu R:

$$U_R = U_2 - U_1 = 3.0 - 2.0 = 1.0 \text{ [V]}$$

$$R = U_R / I_R = 3.0 \text{ V} / 5 \text{ mA} = 600 \text{ } \Omega$$

Pri konzistencií je $P = U_R I_R = 1.0V \cdot .5mA = 5 \text{ mW}$

Takáto hodnota odporu sa nevyrába. Ako postupovať?

Rezistor sa vyrába v radoch E6, E12, E24, E48, E96, E192 zodp. presnosť $\pm 20\%$, $\pm 10\%$.

Rady do technickej praxe zaviedol francúzsky technik Charles Renard.

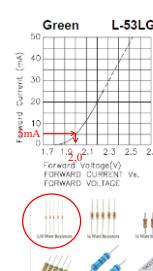
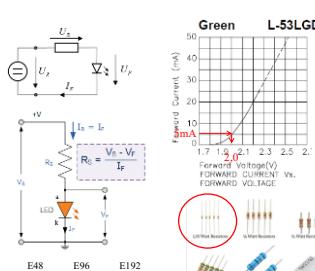


Schéma zapojenia?



NIE

Schéma zapojenia?

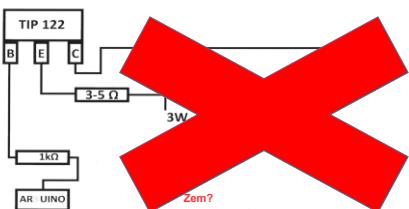


Schéma zapojenia

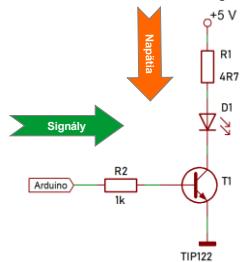
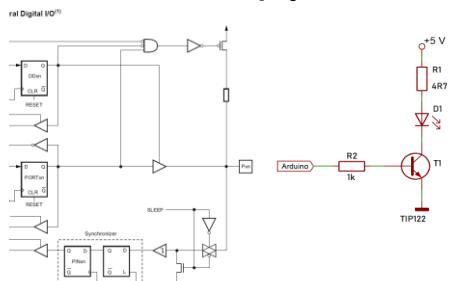
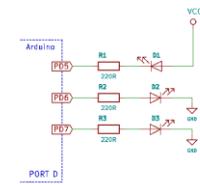
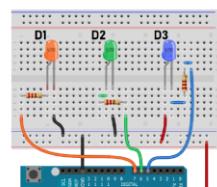


Schéma zapojenia

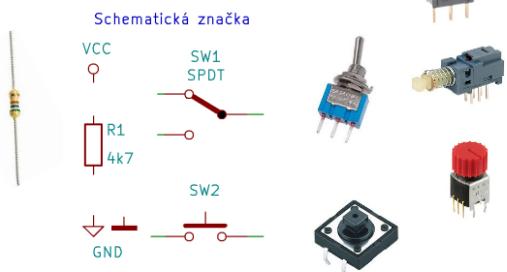


Schémy zapojenia

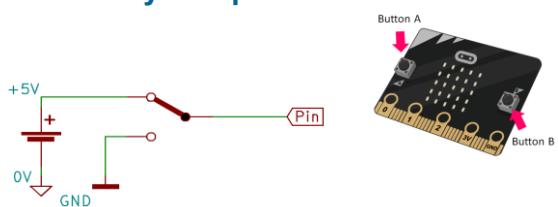


Obr. 1.36: Vľavo zapojovací diagram, vpravo štandardné schéma zapojenia.

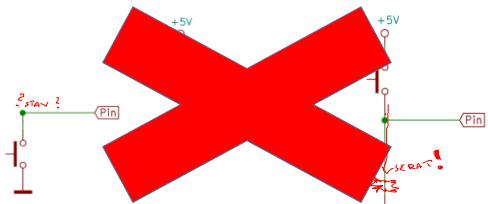
Schémy zapojenia



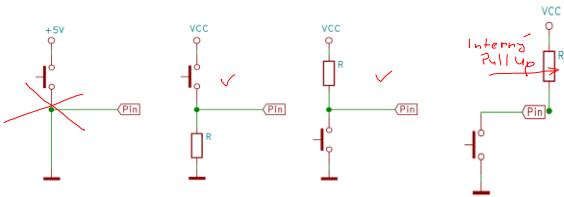
Jednabitový vstup - tlačítko



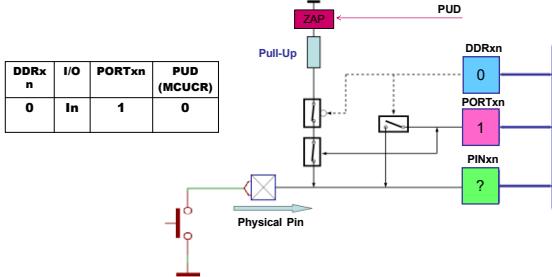
Jednabitový vstup - tlačítko



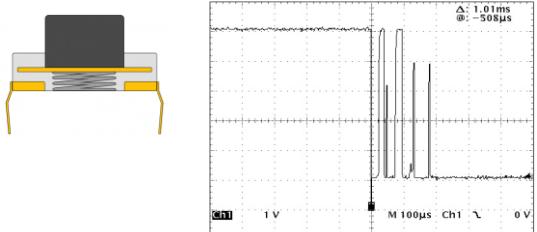
Jednabitový vstup - tlačítko



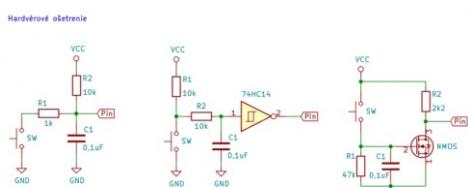
GPIO / Pull-up rezistory



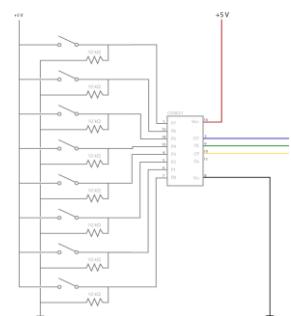
Ošetrenie základov: debouncing



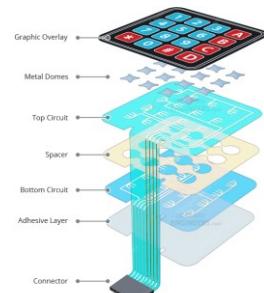
Ošetrenie základov: debouncing



Vstup – klávesnica



Maticová klávesnica



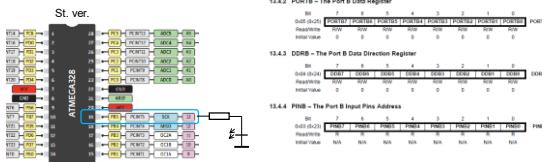
Maticová klávesnica



Programovanie I/O bitov v assembleri

```
START:    SBI 0x04,5      ; DDRB.5 = 1 (t.j. Output)
LOOP:    SBI 0x05,5      ; PORTB.5 = 1 (t.j. High, rozsviet LED)
        CBI 0x05,5      ; PORTB.5 = 0 (t.j. Low, zhasni LED)
```

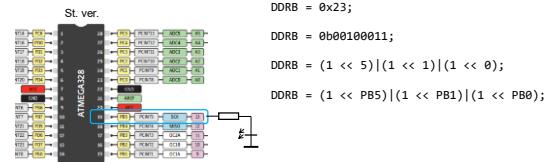
OPAKOVANIE ✓



Programovanie I/O bitov v jazyku C

```
DDRDB = DDRB | 0x20; // PORTB.5 je výstup - tri rôzne spôsoby
DDRB = DDRB | (1<<5);
DDRB |= (1 << PB5);

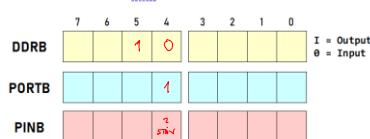
PORTB |= (1<<LED1); // set PB5 na Log. 1 , t.j. rozsviet LED
PORTB &= ~(1<<LED1); // clear PB5 na Log. 0, t.j. zhasni LED
```



```
#define BUTTON PB4
#define LED PB5

DDRDB = (1 << LED); // set LED pin as output
DDRB |= (1 << LED);

DDRDB &= ~(1 << BUTTON); // set BUTTON pin as input
PORTB |= (1 << BUTTON); // set internal pull-up ON
PORTB |= (1 << LED); // turn LED ON
```



Toggle bit

Toggle = zmena: ak bol bit 1 tak nech je 0 a naopak.

AVR implementuje funkciu toggle zápisom 1 do registra PIN

Napr.: PINB = 0b00100000;
alebo
SBI PORTB,5

zmene stav B5 (ak je to výstup)

Datasheet:
"Writing a logic one to PINxn toggles the value of PORTxn, independent on the value of DDRxn."

microcontroller specific feature
(ATmega 16...328)

